

Census Bureau's gold standard Master Address File. This ensures the Panel is rooted in this rigorously developed and maintained frame and available for linkage to administrative records securely maintained and curated by the Census Bureau. Invitations to complete the monthly surveys will be sent via email and SMS messages.

Questionnaires will be mainly internet self-response. The Panel will maintain representativeness by allowing respondents who do not use the internet to respond via computer-assisted telephone interviewing (CATI). All panelists will receive an incentive for each complete questionnaire. Periodic replenishment samples will maintain representativeness and panelists will be replaced after a period of three years.

*Affected Public:* Individuals or Households.

*Frequency:* Monthly.

*Respondent's Obligation:* Voluntary.

*Legal Authority:* Title 13, United States Code, sections 141, 182 and 193.

This information collection request may be viewed at <https://www.reginfo.gov>. Follow the instructions to view the Department of Commerce collections currently under review by OMB.

Written comments and recommendations for the proposed information collection should be submitted within 30 days of the publication of this notice on the following website <https://www.reginfo.gov/public/do/PRAMain>. Find this particular information collection by selecting "Currently under 30-day Review—Open for Public Comments" or by using the search function and entering either the title of the collection or the OMB Control Number 0607–1025.

**Mary Reuling Lenaiyasa,**

*Paperwork Reduction Act Program Manager, Policy Coordination Office, U.S. Census Bureau.*

[FR Doc. 2024–15347 Filed 7–11–24; 8:45 am]

**BILLING CODE 3510–07–P**

## DEPARTMENT OF COMMERCE

### Economic Development Administration

#### Agency Information Collection Activities; Submission for OMB Review; Comment Request; Regional Economic Development Data Collection Instrument

**AGENCY:** Economic Development Administration, Department of Commerce.

**ACTION:** Notice of information collection, request for comment.

**SUMMARY:** The Department of Commerce will submit the following information collection request to the Office of Management and Budget (OMB) for review and clearance in accordance with the Paperwork Reduction Act of 1995, on or after the date of publication of this notice. We invite the general public and other Federal agencies to comment on proposed, and continuing information collections, which helps us assess the impact of our information collection requirements and minimize the public's reporting burden.

**ADDRESSES:** Interested persons are invited to submit written comments via email to Hallie Davis, Tech Hubs Program Analyst, Economic Development Administration, at [HDavis1@eda.gov](mailto:HDavis1@eda.gov) or [PRAComments@doc.gov](mailto:PRAComments@doc.gov). Do not submit Confidential Business Information or otherwise sensitive or protected information.

**FOR FURTHER INFORMATION CONTACT:** Requests for additional information or specific questions related to collection activities should be directed to Tech Hubs, Economic Development Administration, at [TechHubs@eda.gov](mailto:TechHubs@eda.gov).

#### **SUPPLEMENTARY INFORMATION:**

##### **I. Abstract**

The Economic Development Administration (EDA) leads the Federal economic development agenda by promoting innovation and competitiveness, and preparing American regions for growth and success in the worldwide economy. Guided by the basic principle that sustainable economic development should be driven locally, EDA works directly with communities and regions to help them build the capacity for economic development based on local business conditions and needs. Section 28 of the Stevenson-Wydler Technology Innovation Act of 1980 (Regional Technology and Innovation Hub Program (15 U.S.C. 3722a) is the legal authority under which EDA awards financial assistance and designee status under the Fiscal Year (FY) 23 Regional Technology and Innovation Hub Program ("Tech Hubs"). Under Tech Hubs, EDA seeks to strengthen U.S. economic and national security through place-based investments in regions with the assets, resources, capacity, and potential to become globally competitive, within approximately ten years, in the technologies and industries of the future—and for those industries, companies, and the good jobs they create to start, grow, and remain in the U.S. in order to support the growth and modernization of U.S. manufacturing, improve commercialization of the

domestic production of innovative research, and strengthen U.S. economic and national security. Tech Hubs is a two-phase program: in Phase 1, EDA funded Strategy Development grants and designated 31 regions as Tech Hubs. In Phase 2, designated Tech Hubs are eligible to compete for funding for implementation projects. Further information on Tech Hubs can be found at [www.eda.gov](http://www.eda.gov).

Public comments were previously requested via the **Federal Register** on April 19, 2024 during a 60-day comment period (89 FR 28732). This notice allows for an additional 30 days for public comments. The purpose of this notice is to seek comments from the public and other Federal agencies on a request for a new information collection for designated Tech Hubs to help ensure that Tech Hub investments are evidence-based, data-driven, and accountable to participants and the public.

Lead consortium members of the 31 designated Tech Hubs will submit identified program metrics and qualitative information to help assess specific program objectives. A one-time questionnaire will be sent to each of the Tech Hubs consortium leads, which will gather the relevant data and stories for each of the 31 Tech Hubs designee consortia, resulting in consortia regional impact evaluation, resources, and tools for regional economic development decision-makers. The 31 designated Tech Hubs will provide information on the following objectives:

(1) Accelerating technology innovation, commercialization, demonstration, and deployment, which may include information on the number of patents filed, licensing agreements, approximate levels of research and development expenditures, adoption of new technologies, and acceleration of current technologies.

(2) Enabling infrastructure and advancing manufacturing, which may include information on specific facility information.

(3) Integrating an agile workforce system, which may include information on skills needed by employers, available training, hard-to-fill vacancies, policies and strategies for worker retention, and strategies for engagement with underserved workers.

(4) Increasing business and entrepreneurial capacity, which may include assessing employer competitiveness, relationships with Federal, State, and local entities, current partnerships, and information about sources of capital to start and grow businesses and to adopt innovative approaches and technologies.

(5) Strengthening national security, which may include information on procurement processes, critical inputs, sourcing, supply chains, and strategic implications of technologies and their use cases.

Tech Hubs designees must submit this data one time to provide a baseline status of the Tech Hub and to help assess the results of designee status as well as potential future federal investments.

EDA is particularly interested in public comment on how the proposed data collection will support the assessment of job quality, including in ways that rely on pairing this information administrative data for analysis and other ways to minimize burden, or if alternative information should be considered.

**II. Method of Collection**

Data will be collected electronically.

**III. Data**

*OMB Control Number:* None: new information collection.

*Form Number(s):* None: New information collection.

*Type of Review:* Regular submission: new information collection.

*Affected Public:* Tech Hubs designees, which may include a(n): Institution of higher education, including Historically Black Colleges and Universities, Tribal Colleges or Universities, and Minority-Serving Institutions; State, territorial, local or Tribal governments or other political subdivisions of a State, including State and local agencies, or a consortium thereof; Industry groups or firms in relevant technology, innovation, or manufacturing sectors; Economic development organizations or similar entities that are focused primarily on improving science, technology, innovation, entrepreneurship, or access to capital; Labor organizations or workforce training organizations, which may include State and local workforce development boards; Economic development entities with relevant expertise, including a district organization; Organizations that contribute to increasing the participation of underserved populations in science, technology, innovation, and entrepreneurship; Venture development organizations; Organizations that promote local economic stability, high wage domestic jobs, and broad-based economic opportunities, such as employee

ownership membership associations and State or local employee ownerships and cooperative development centers, financial institutions and investment funds, including community development financial institutions and minority depository institutions; Elementary schools and secondary schools, including area career and technical education schools; National laboratories; Federal laboratories; Manufacturing extension centers; Manufacturing U.S.A. Institutes; Transportation planning organizations; A cooperative extension services; Organizations that represent the perspectives of underserved communities in economic development initiatives; and Institutions receiving an award under the National Science Foundation’s (NSF) Regional Innovation Engines Program.

*Preliminary Estimated Number of Respondents:* Consortium Lead Members/Tech Hubs Designee Consortia: 31 respondents, responding once.

*Estimated Time Per Response:* Consortium Lead Members/Tech Hubs Designee Consortia: 3 hours.

*Estimated Total Annual Burden Hours:* 93 hours.

Type of respondent (one time)	Number of respondents	Hours per response	Number of responses per year	Total estimated time (hours)
Lead Consortium Members/Tech Hubs Designee Consortia .....	31	3	1 (Once)	93
Total .....	31	3	1	93

*Estimated Total Annual Cost to Public:* \$ 5,769.72 (cost assumes application of U.S. Bureau of Labor Statistics second quarter 2022 mean hourly employer costs for employee compensation for professional and related occupations of \$62.04).

*Respondent’s Obligation:* Mandatory for Consortium Lead Members.

*Legal Authority:* Stevenson Wydler Technology Innovation Act of 1980, section 28 (15 U.S.C. 3722a).

**IV. Request for Comments**

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Written comments and recommendations for the proposed information collection should be submitted within 30 days of the publication of this notice on the following website [www.reginfo.gov/](http://www.reginfo.gov/)

*public/do/PRAMain.* Find this particular information collection by selecting “Currently under 30-day Review—Open for Public Comments.”

**Oliver Wise,**  
*Chief Data Officer and Acting Under Secretary for Economic Affairs, Commerce Department.*

[FR Doc. 2024–15183 Filed 7–11–24; 8:45 am]

**BILLING CODE 3510–34–P**

**DEPARTMENT OF COMMERCE**

**International Trade Administration**

[A–520–807]

**Circular Welded Carbon-Quality Steel Pipe From the United Arab Emirates: Final Results of Antidumping Duty Administrative Review; 2021–2022**

**AGENCY:** Enforcement and Compliance, International Trade Administration, Department of Commerce.

**SUMMARY:** The U.S. Department of Commerce (Commerce) determines that producers/exporters of circular welded carbon-quality steel pipe (CWP) made sales of subject merchandise at less than normal value (NV) during the period of review (POR), December 1, 2021, through November 30, 2022.

**DATES:** Applicable July 12, 2024.

**FOR FURTHER INFORMATION CONTACT:** Rebecca Janz or Sofia Pedrelli, AD/CVD